

Features

- Top view 2016 package
- Viewing Angle = ±60°
- Compatible with infrared and vapor phase reflow solder process
- High reliability
- Ultra bright Blue
- RoHS compliance

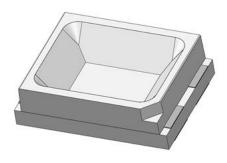
Applications

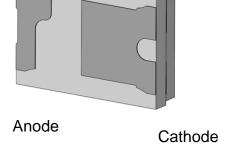
- Optical indicator.
- Switch and Symbol Display.

Description

The BC201607-ATC4 InGaN Blue LED housed in a miniature SMD package. The device has a dominant wavelength of 470 nm LED.

Package Outline





Schematic

Cathode
$$-$$
 Anode $(-)$



Absolute Maximum Rating at 25°C

Symbol	Parameters	Ratings	Units	Notes
l _F	Continuous Forward Current	30	mA	
I _{FP}	Peak Forward Current	100	mA	1
V _R	Reverse Voltage	5	V	
Topr	Operating Temperature	-40 ~ +85	∘C	
T _{stg}	Storage Temperature	-40 ~ +100	°C	
T _{sol}	Soldering Temperature	260	∘C	2
PD	Power Dissipation at(or below) 25°C Free Air Temperature	110	mW	

Electro-Optical Characteristics TA = 25°C (unless otherwise specified)

Optical Characteristics

Symbol	Parameters	Test Conditions	Min	Тур	Max	Units	Notes
lv	Luminous Intensity	I _F =20mA	225	•	450	mcd	3
λd	Dominant Wavelength	I _F =20mA	460	-	475	nm	4
θ1/2	Angle of Half Intensity	I _F =20mA	-	±60	-	deg	

Electrical Characteristics

Symbol	Parameters	Test Conditions	Min	Тур	Max	Units	Notes
VF	Forward Voltage	I _F =20mA	2.7	-	3.5	V	5
I _R	Reverse Current	V _R =5V	-	-	10	μA	

Notes:

- 1. Tolerance of Luminous Intensity ±10%.
- 2. Tolerance of Dominant Wavelength: ±1nm.
- 3. Bin Range of Luminous Intensity

Bin Code	Min	Max	Unit	Condition	
S2	225	285		I _F =20mA	
T1	285	360	mcd		
T2	360	450			



4. Bin Range of Dominant Wavelength

Bin Code	Min	Max	Unit	Condition	
A5	460	465			
A6	465	470	nm	I _F =20mA	
A7	470	475			

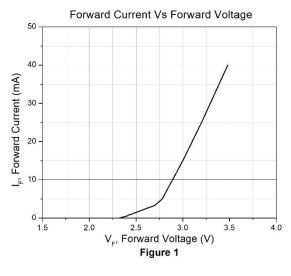
5. Bin Range of Forward Voltage

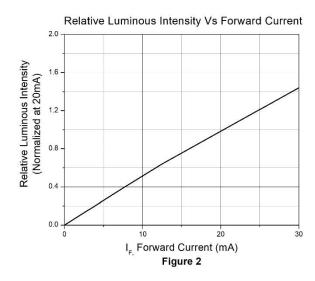
Bin Code	Min	Max	Unit	Condition	
V9	2.7	2.9		I _F =20mA	
V10	2.9	3.1	V		
V11	3.1	3.3	V		
V12	3.3	3.5			

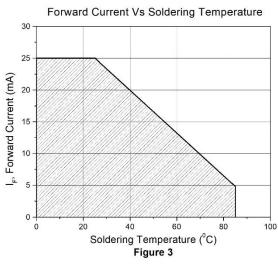
Tolerance of Forward Voltage: ±0.1V.

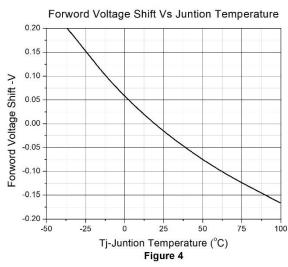


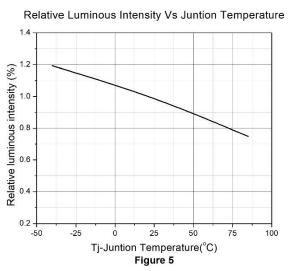
Typical Characteristic Curves

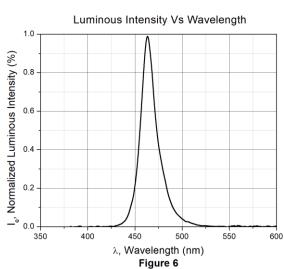








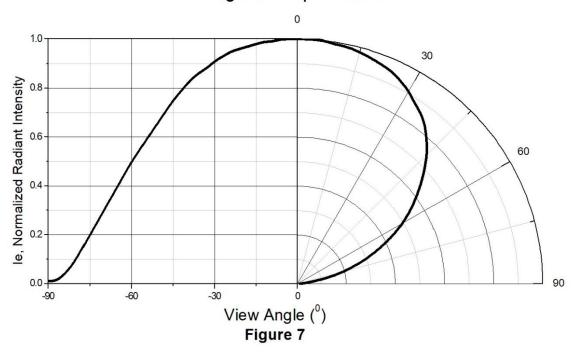






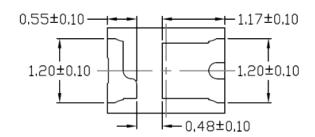
Typical Characteristic Curves

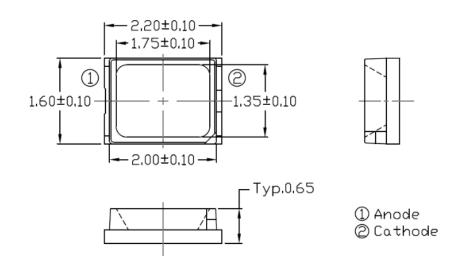
Angular Displacement





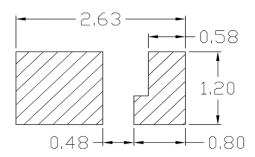
Package Dimension All dimensions are in mm, unless otherwise stated





Note: Tolerance unless mentioned is ±0.1mm

Recommended Soldering Mask All dimensions are in mm, unless otherwise stated



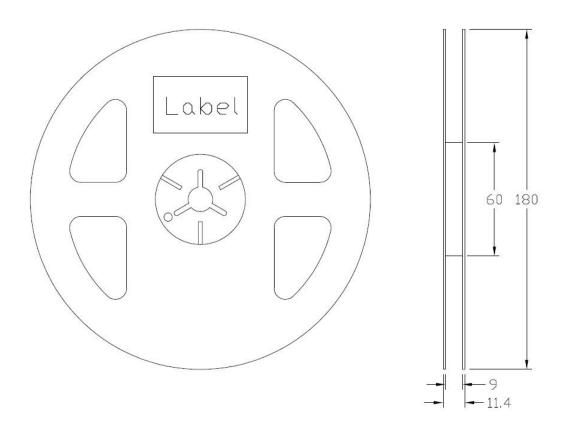
Note: Tolerance unless mentioned is ±0.1mm

Ordering Information

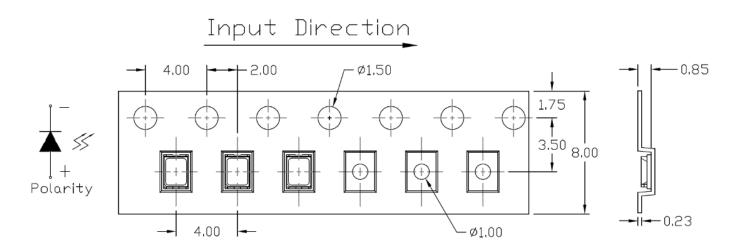
Part Number	Description	Quantity
BC201607-ATC4	Tape & Reel	4000 pcs



Reel Dimension All dimensions are in mm, unless otherwise stated



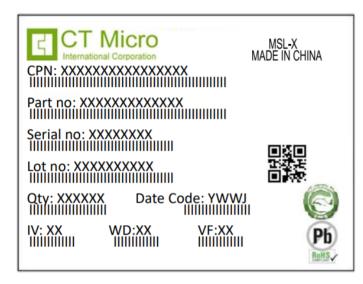
Tape Dimension All dimensions are in mm, unless otherwise stated



Note: Tolerance unless mentioned is ±0.1mm



Label Form Specification



CPN : Customer Part Number Part no: CTM Production Number

Serial no: Production Number

Lot no: Lot number

Q'ty: Packing Quantity

Date Code: Manufacture Date

IV: Bin Code of Luminous Intensity

WD: Bin Code of Dominant Wavelength

VF : Bin Code of Forward Voltage

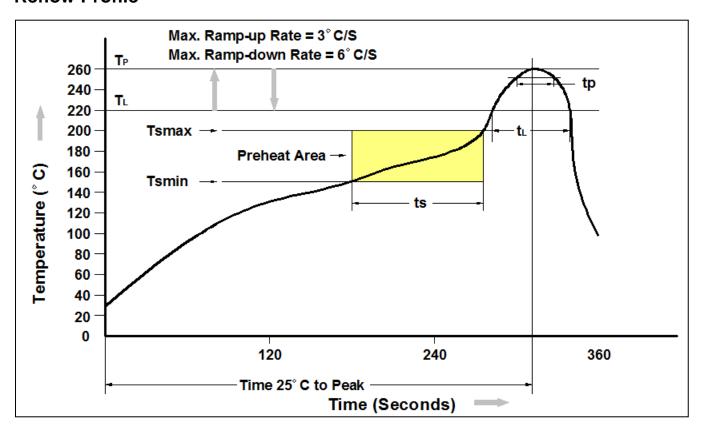
MADE IN CHINA: Production Place

Storage Condition

- 1. Do not open moisture proof bag before the products are ready to use.
- 2. The moisture barrier bag should be stored at 30°C and 90%R.H. max. before opening. Shelf life of non-opened bag is 12 months after the bag sealing date.
- 3. After opening the moisture barrier bag floor life is 168h at 30°C/60%RH. max. Unused LEDs should be resealed into moisture barrier bag. (Refer to J-STD-020 Standard)
- 4. If the moisture absorbent material has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the J-STD-033 Standard conditions.



Reflow Profile



Profile Feature	Pb-Free Assembly Profile
Temperature Min. (Tsmin)	150°C
Temperature Max. (Tsmax)	200°C
Time (ts) from (Tsmin to Tsmax)	60-120 seconds
Ramp-up Rate (t∟ to t _P)	3°C/second max.
Liquidous Temperature (T _L)	217°C
Time (t _L) Maintained Above (T _L)	60 – 150 seconds
Peak Body Package Temperature	260°C +0°C / -5°C
Time (t _P) within 5°C of 260°C	30 seconds
Ramp-down Rate (T _P to T _L)	6°C/second max
Time 25°C to Peak Temperature	8 minutes max.

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